

A

B

C

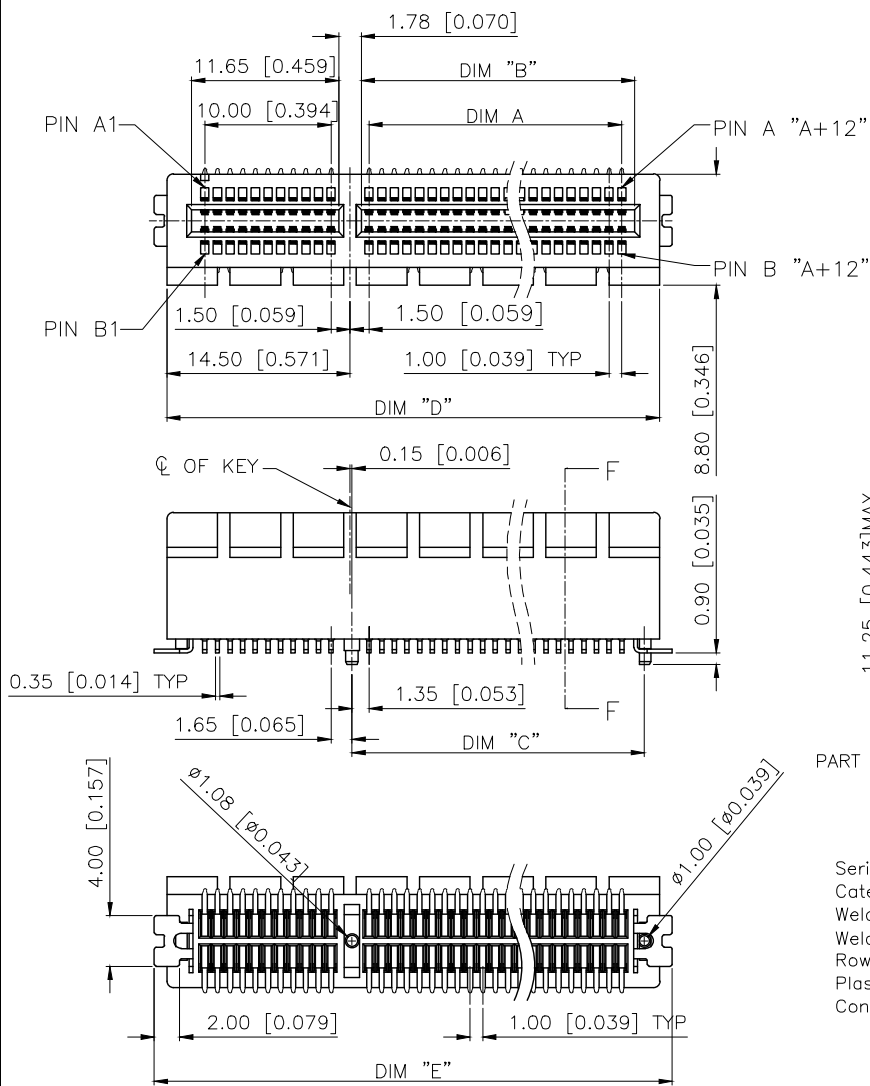
D

A

B

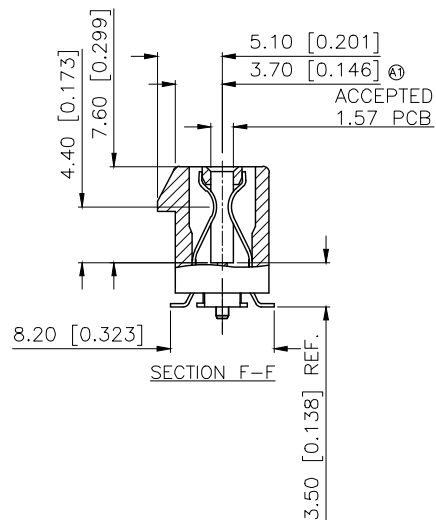
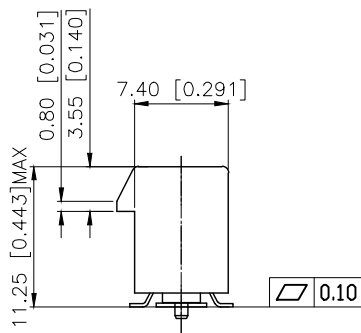
C

D



REVISIONS					
REV.	ECN NO.	LOCATION	DESCRIPTION	DATE	DESIGN
A0	N/A		INITIAL RELEASE	/	/
A1	N/A	①X2		2024.02.24	

- NOTES:
- MATERIAL:
 - 1.1 HOUSING: THERMOPLASTIC, HIGH TEMP, UL94V-0, COLOR: SEE PART NO..
 - 1.2 CONTACTS: COPPER ALLOY.
 - 1.3 HOLDDOWN: COPPER ALLOY.
 - FINISH:
 - 2.1 CONTACT:
 - SELECTIVE GOLD PLATING ON THE CONTACT AREA.
 - MATTE TIN PLATING ON THE SOLDER TAILS,
 - NICKEL UNDERPLATING OVERALL.
 - 2.2 HOLDDOWN:
 - MATTE TIN PLATING WITH NICKEL UNDERPLATE OVERALL.



PART NO.:
X3113 W V S-XX-9T V01

Series No
Category:W-Wafer
Welding Board Angle:V-Straight 180°
Welding Way: S-SMT
Row No-Pin No:36~164 Pin
Plastic material: PA9T/PA46 UL94V-0
Contact Plating: V01-Gold Flash
V15-Gold 15u"
V30-Gold 30u"

DIMENSIONS					
POSITION	A±0.20	B ^{+0.20} _{-0.08}	C±0.20	D±0.25	E±0.30
36	6	7.65	9.15	25.00	27.00
64	20	21.65	23.15	39.00	41.00
98	37	38.65	40.15	56.00	58.00
164	70	71.65	73.15	89.00	91.00

AuGLAR	±5°
X.	±0.40
X.x	±0.30
X.xx	±0.20
X.xxx	±0.15
UNSPECIFIED TOLERANCES	



DESIGN		VIEW:	MODEL TYPE: PCI EXPRESS SMT TYPE
CHECKED		UNIT: mm/in	PART NO.: X3113WVS-XX-9TV01
APPROVED		SIZE: A4	DWG NO.:

SCALE	PAGE	REVISION
N/A	1/2	A1

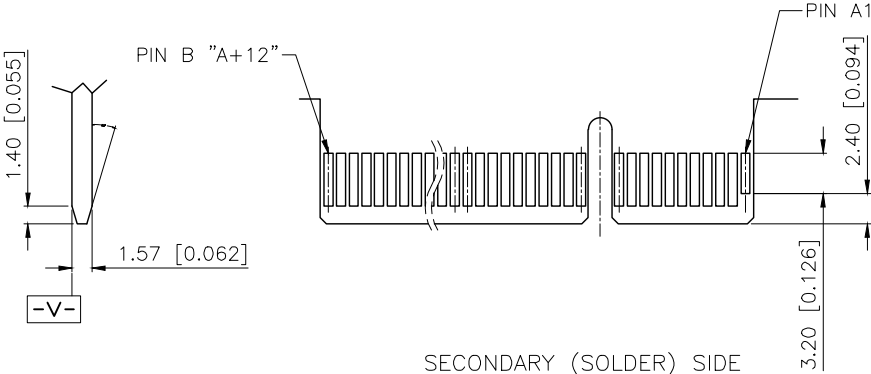
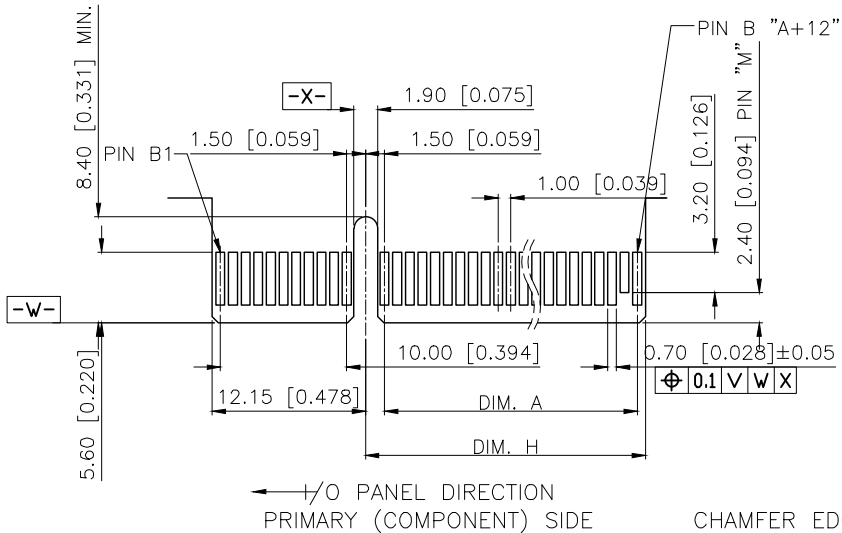
A

B

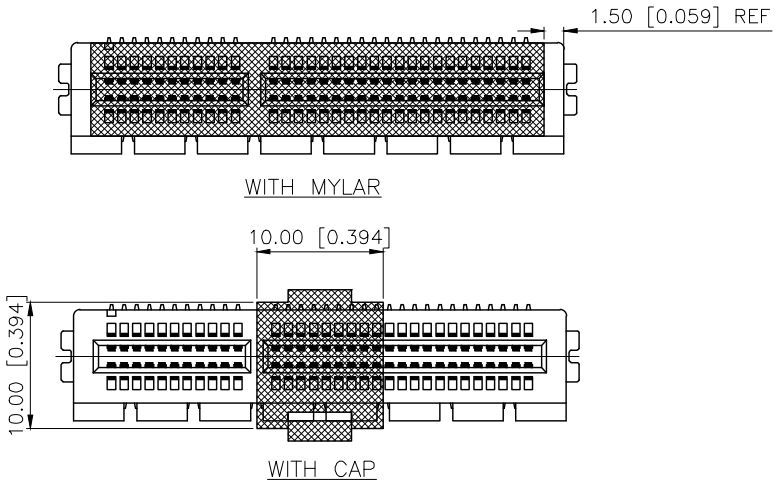
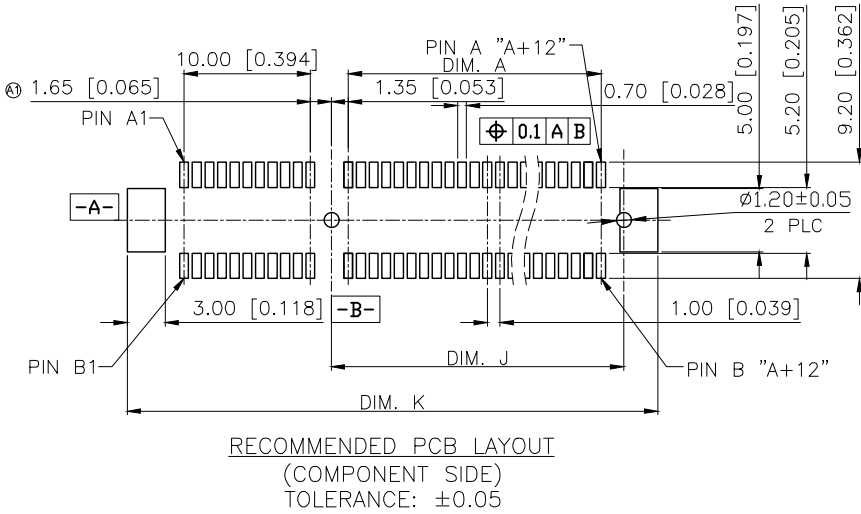
C

D

REVISIONS					
REV.	ECN NO.	LOCATION	DESCRIPTION	DATE	DESIGN
A0	N/A		INITIAL RELEASE	/	I
A1	N/A	Ⓐ)X3		2024.02.24	



NOTES:
CHAMFER EDGE MUST BE FREE OF CUTTING BURRS



POS.	DIM. A	DIM. H	DIM. J	DIM. K	"M"	AuGLAR	±5°
36	6	8.15	9.15	28.0	B17	X.	±0.40
64	20	22.15	23.15	42.0	B31	X.x	±0.30
98	37	39.15	40.15	59.0	B48	X.xx	±0.20
164	70	72.15	73.15	92.0	B81	X.xxx	±0.15
UNSPECIFIED TOLERANCES							±0.05



DESIGN		VIEWS	MODEL TYPE: PCI EXPRESS SMT TYPE
CHECKED		UNIT: mm/in	PART NO.: X3113WVS-XX-9TV01
APPROVED		SIZE: A4	DWG NO.:
XKB INDUSTRIAL PRECISION CO.,LIMITED			SCALE N/A
			PAGE 2/2
			REVISION A1